



N-Channel 20 V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	I _D (A)	Q _g (Typ.)	
20	0.089 at V _{GS} = 4.5 V	1.32		
	0.098 at V _{GS} = 2.5 V	1.26	5.2	
	0.121 at V _{GS} = 1.8 V	1.13		

FEATURES

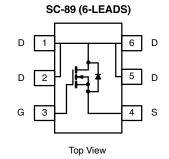
- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Power MOSFET
- 100 % R_g Tested
- Compliant to RoHS Directive 2002/95/EC

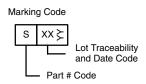


ROHS COMPLIANT HALOGEN FREE

APPLICATIONS

· Load Switch for Portable Devices





Ordering Information: Si1056X-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted)					
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V_{DS}	20	V	
Gate-Source Voltage		V_{GS}	± 8	V	
Continuous Dunin Commant /T 150 90\8	T _A = 25 °C	I_	1.32 ^{b, c}		
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 70 °C	l _D	1.05 ^{b, c}	Α	
Pulsed Drain Current		I _{DM}	6	A	
Avalanche Current	L = 0.1 mH	I _{AS}	8		
Repetitive Avalanche Energy	etitive Avalanche Energy		3.2	mJ	
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	0.2 ^{b, c}	А	
Mariana Barra Biraira itan 8	T _A = 25 °C	P _D	0.236 ^{b, c}	W	
Maximum Power Dissipation ^a	T _A = 70 °C		0.151 ^{b, c}	VV	
Operating Junction and Storage Temperature Ra	T _J , T _{stg}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Marrian Innation to Ambienth d	t ≤ 5 s	R_{thJA}	440	530	°C/W	
Maximum Junction-to-Ambient ^{b, d}	Steady State		540	650		

Notes:

- a. Based on $T_C = 25$ °C.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 5 s
- d. Maximum under steady state conditions is 650 °C/W.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	20			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	1 - 2504		18.2		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA		- 2.71			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	0.35		0.95	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			± 100	nA	
Zone Onto Valla de Bueiro Occurs	I _{DSS}	V _{DS} = 20 V, V _{GS} = 0 V			1	μΑ	
Zero Gate Voltage Drain Current		V _{DS} = 20 V, V _{GS} = 0 V, T _J = 85 °C			10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} = \ge 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	6			Α	
		$V_{GS} = 4.5 \text{ V}, I_D = 1.32 \text{ A}$		0.074	0.089		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 2.5 V, I _D = 1.26 A		0.082	0.098	Ω	
		V _{GS} = 1.8 V, I _D = 1.13 A		0.093	0.121		
Forward Transconductance	9 _{fs}	V _{DS} = 10 V, I _D = 1.32 A		7.5		S	
Dynamic ^b						•	
Input Capacitance	C _{iss}			400			
Output Capacitance	C _{oss}	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		70		pF	
Reverse Transfer Capacitance	C _{rss}			40		1	
Total Cata Charge	V ₂₀ = 1	$V_{DS} = 10 \text{ V}, V_{GS} = 5 \text{ V}, I_{D} = 1.32 \text{ A}$		5.8	8.7		
Total Gate Charge	Q_{g}			5.2	7.8	0	
Gate-Source Charge	Q_{gs} V_D	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 1.32 \text{ A}$		0.83		nC	
Gate-Drain Charge	Q _{gd}			0.71			
Gate Resistance	R _g	f = 1 MHz		3.8	5.7	Ω	
Turn-On Delay Time	t _{d(on)}			6.8	10.2		
Rise Time	t _r	$V_{DD} = 10 \text{ V}, R_L = 9.52 \Omega$		19	28.5	ns	
Turn-Off Delay Time	t _{d(off)}	$I_{D} \cong 1.05 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_{g} = 1 \Omega$		18	27		
Fall Time	t _f			6	9		
Drain-Source Body Diode Characterist	cs						
Pulse Diode Forward Current ^a	I _{SM}				6	Α	
Body Diode Voltage	V_{SD}	I _S = 1.0 A		0.8	1.2	V	
Body Diode Reverse Recovery Time t _{rr}				10.0	15	nC	
Body Diode Reverse Recovery Charge	Q _{rr}	1 1 0 A dl/dt 100 A/:		3.5	5.3		
Reverse Recovery Fall Time	t _a	I _F = 1.0 A, dl/dt = 100 A/μs		6.6		ns	
Reverse Recovery Rise Time	t _b			3.4			

Notes:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.

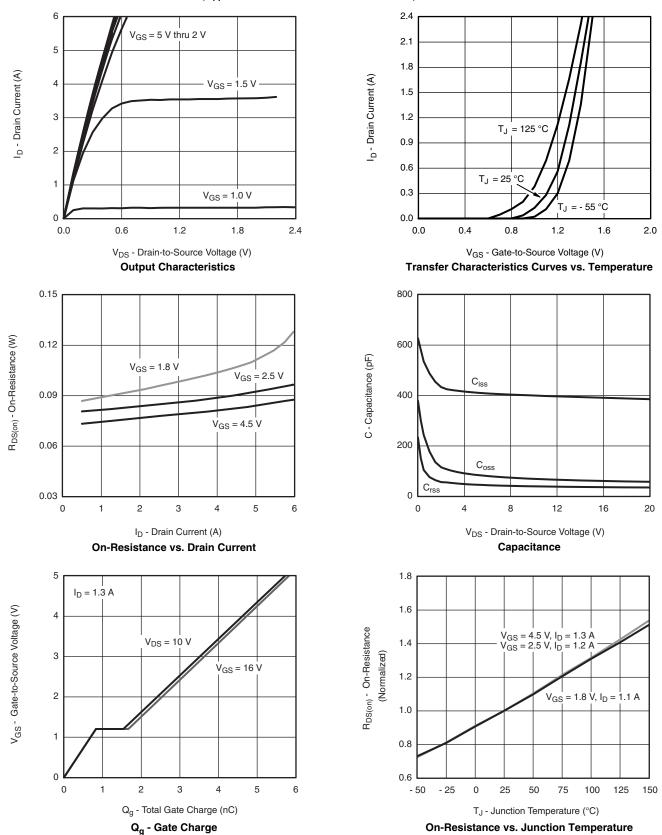
b. Guaranteed by design, not subject to production testing.







TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)



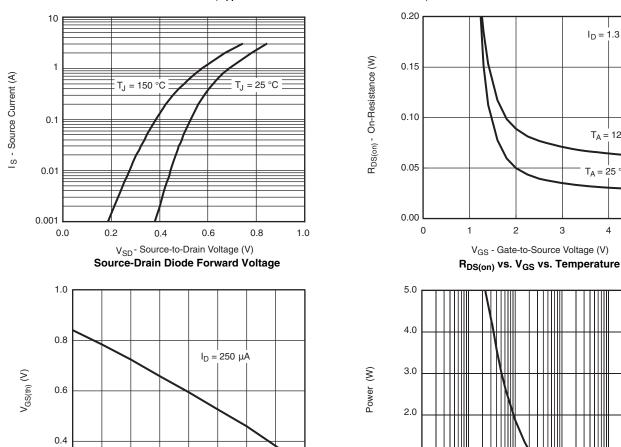
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 $I_D = 1.3 A$

T_A = 125 °C

T_A = 25 °C

TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



T_J - Temperature (°C)

50

75

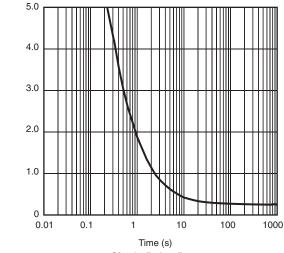
100

125

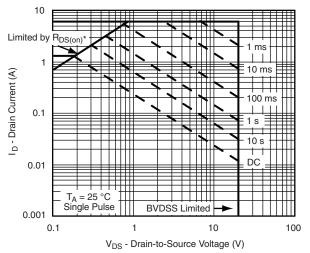
150

25

Threshold Voltage



Single Pulse Power



 * V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

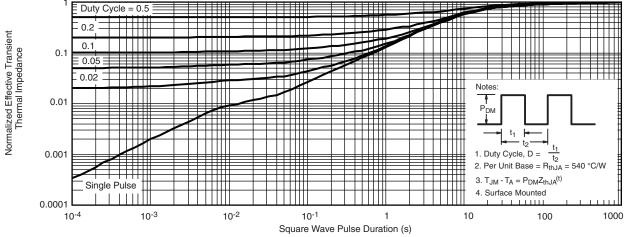
Safe Operating Area, Junction-to-Ambient

0.2 - 50

- 25



TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?73895.



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Revision: 02-Oct-12 Document Number: 91000